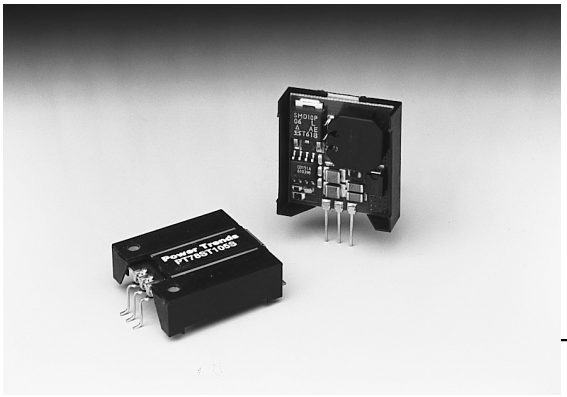
PT78ST100 Series

1.5 Amp Positive Step-Down Integrated Switching Regulator

Power Trends Products from Texas Instruments

SLTS059A

(Revised 6/30/2000)



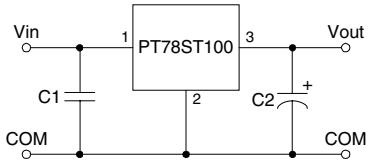
- Very Small Footprint
- High Efficiency > 85%
- Self-Contained Inductor
- Internal Short-Circuit Protection
- Over-Temperature Protection
- Fast Transient Response
- Wide Input Range

The PT78ST100 is a series of wide-input range, 3-terminal regulators.

These ISRs have a maximum output current of 1.5 Amps and an output voltage that is laser trimmed to a variety of industry standard voltages.

These 78 series regulators have excellent line and load regulation with internal short- circuit and over-temperature protection, and are offered in a variety of standard output voltages. These ISRs are very flexible and may be used in a wide variety of applications.

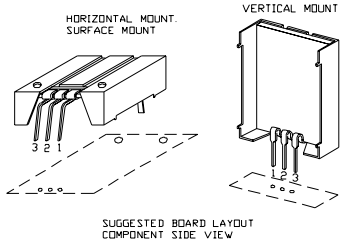
Standard Application



C1 = Optional 1µF ceramic
C2 = Required 100µF electrolytic

Pin-Out Information

Pin	Function
1	V_{in}
2	GND
3	V_{out}



Pkg Style 500

Ordering Information

PT78ST1 XX Y

Output Voltage

33 = 3.3 Volts
36 = 3.6 Volts
05 = 5.0 Volts
51 = 5.1 Volts
53 = 5.25 Volts
06 = 6.0 Volts
65 = 6.5 Volts
07 = 7.0 Volts
08 = 8.0 Volts
09 = 9.0 Volts
10 = 10.0 Volts
12 = 12.0 Volts
14 = 13.9 Volts
15 = 15.0 Volts

Package Suffix

V = Vertical Mount
S = Surface Mount
H = Horizontal Mount

Specifications

Characteristics (T_a = 25°C unless noted)	Symbols	Conditions	PT78ST100 SERIES Min	Typ	Max	Units
Output Current	I_o	Over V_{in} range	0.1*	—	1.5	A
Short Circuit Current	I_{sc}	V_{in} = V_{in} min	—	3.5	—	Apk
Input Voltage Range	V_{in}	0.1 ≤ I_o ≤ 1.5A V_o= 3.3V V_o= 5V V_o= 12V	9 9 16	— — —	26 38 38	V V V
Output Voltage Tolerance	ΔV_o	Over V_{in} range, I_o=1.5A T_a = 0°C to +60°C	—	±1.0	±2.0	%V_O
Line Regulation	Reg_{line}	Over V_{in} range	—	±0.2	±0.4	%V_O
Load Regulation	Reg_{load}	0.1 ≤ I_o ≤ 1.5A	—	±0.1	±0.2	%V_O
V_o Ripple/Noise	V_n	V_{in}= 9V, I_o= 1.5A V_o= 5V V_{in}= 16V, I_o= 1.5A V_o= 12V	—	65 90	—	mV_{pp} mV_{pp}
Transient Response (with 100µF output cap)	t_{tr}	50% load change V_o over/undershoot	— —	100 5	— —	µSec %V_O
Efficiency	η	V_{in}= 10V, I_o= 1A V_o= 3.3V V_{in}= 10V, I_o= 1A V_o= 5V V_{in}= 17V, I_o= 1A V_o= 12V	— — —	80 85 90	— — —	% % %
Switching Frequency	f_o	Over V_{in} range, I_o=1.5A	600	650	700	kHz
Absolute Maximum Operating Temperature Range	T_a	—	-40	—	+85	°C
Recommended Operating Temperature Range	T_a	Free Air Convection, (40-60LFM) At V_{in}= 24V, I_o=1.0A	-40	—	+80**	°C
Thermal Resistance	θ_{ja}	Free Air Convection, (40-60LFM)	—	45	—	°C/W
Storage Temperature	T_s	—	-40	—	+125	°C
Mechanical Shock	—	Per Mil-STD-883D, Method 2002.3	—	500	—	G's
Mechanical Vibration	—	Per Mil-STD-883D, Method 2007.2, 20-2000 Hz, soldered in a PC board	—	5	—	G's
Weight	—	—	—	6.5	—	grams

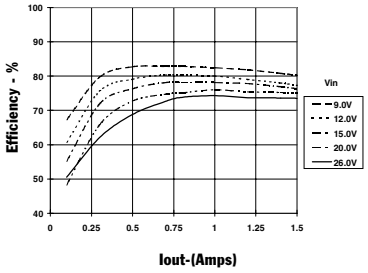
*ISR will operate down to no load with reduced specifications. **See Thermal Derating chart.

Note: *The PT78ST100 Series requires a 100µF electrolytic or tantalum output capacitor for proper operation in all applications.*

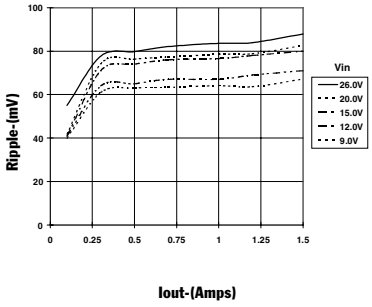
Typical Characteristics

PT78ST133, 3.3 VDC (See Note 1)

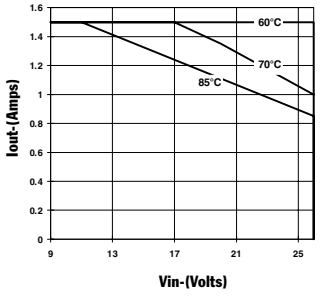
Efficiency vs Output Current



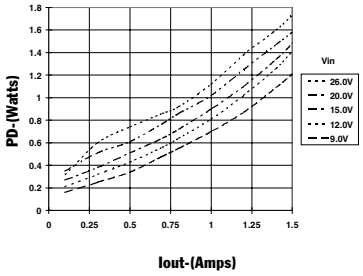
Ripple vs Output Current



Thermal Derating (T_a) (See Note 2)

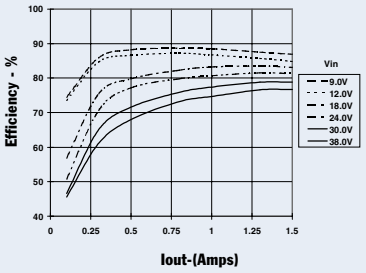


Power Dissipation vs Output Current

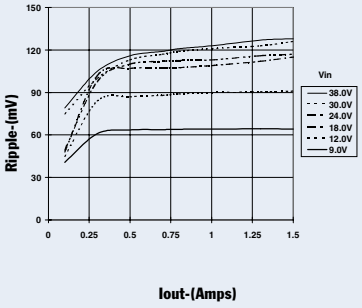


PT78ST105, 5.0 VDC (See Note 1)

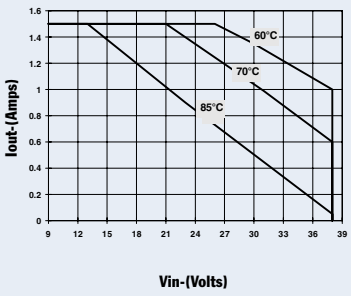
Efficiency vs Output Current



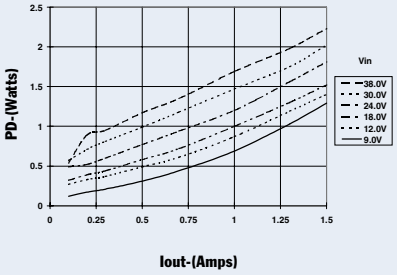
Ripple vs Output Current



Thermal Derating (T_a) (See Note 2)

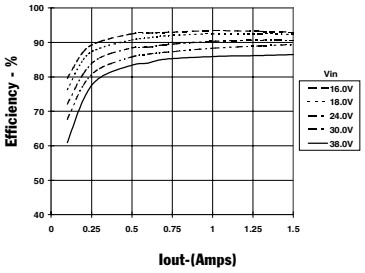


Power Dissipation vs Output Current

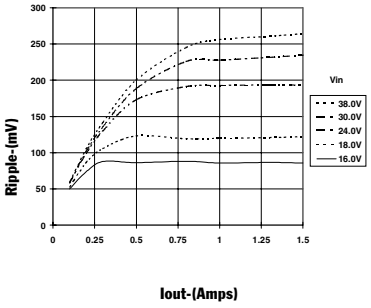


PT78ST112, 12.0 VDC (See Note 1)

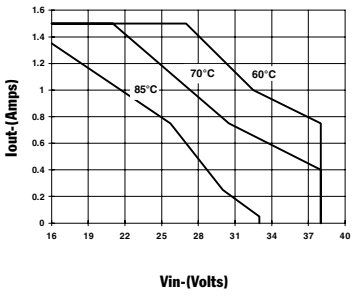
Efficiency vs Output Current



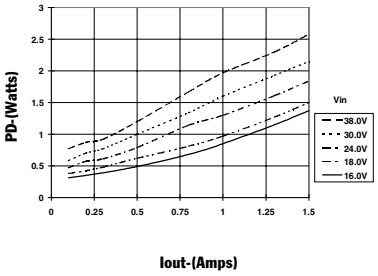
Ripple vs Output Current



Thermal Derating (T_a) (See Note 2)



Power Dissipation vs Output Current



Note 1: *All data listed in the above graphs, except for derating data, has been developed from actual products tested at 25°C. This data is considered typical data for the ISR.*
Note 2: *Thermal derating graphs are developed in free air convection cooling of 40-60 LFM. (See Thermal Application Notes.)*

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/ Ball Finish	MSL Peak Temp (3)	Samples (Requires Login)
PT78ST105H	ACTIVE	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST105S	ACTIVE	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
PT78ST105ST	ACTIVE	SIP MODULE	EFC	3	200	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
PT78ST105U	NRND	SIP MODULE	EFU	3		TBD	Call TI	Call TI	
PT78ST105V	ACTIVE	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST106H	ACTIVE	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST106S	ACTIVE	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
PT78ST106V	ACTIVE	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST107H	ACTIVE	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST107S	ACTIVE	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
PT78ST107ST	OBSOLETE	SIP MODULE	EFC	3		TBD	Call TI	Call TI	
PT78ST108H	ACTIVE	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST108S	ACTIVE	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
PT78ST108V	ACTIVE	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST109H	ACTIVE	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST109S	ACTIVE	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
PT78ST109V	ACTIVE	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST110H	ACTIVE	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST110S	ACTIVE	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
PT78ST110V	ACTIVE	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST112H	ACTIVE	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST112S	ACTIVE	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
PT78ST112V	ACTIVE	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST114S	ACTIVE	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
PT78ST114V	ACTIVE	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST115H	ACTIVE	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST115S	ACTIVE	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
PT78ST115ST	OBSOLETE	SIP MODULE	EFC	3		TBD	Call TI	Call TI	
PT78ST115V	ACTIVE	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST133H	ACTIVE	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/ Ball Finish	MSL Peak Temp (3)	Samples (Requires Login)
PT78ST133S	ACTIVE	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
PT78ST133V	ACTIVE	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST136H	ACTIVE	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST151H	ACTIVE	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST151S	ACTIVE	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
PT78ST153H	ACTIVE	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST153S	ACTIVE	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
PT78ST153V	ACTIVE	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST165H	ACTIVE	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	
PT78ST165S	ACTIVE	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM	
PT78ST165V	ACTIVE	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type	

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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